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Finite-Element Modeling of Thermoelastic Attenuation in Piezoelectric Surface Acoustic Wave Devices

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The assessment of thermoelastic attenuation is crucial in designing surface acoustic wave (SAW) devices. As irregular structures are more and more involved in modern applications for which efficient numerical tools are required, a multi-physics finite-element model is proposed in this paper, where thermoelastic damping in piezoelectric materials can be accounted for in both coated and uncoated conditions. The coupled equations are solved iteratively in time domain, using the Newmark method. The mechanical, electrical, and thermal degrees of freedom are calculated simultaneously at each time step. An application of the model is presented through the investigation of thermoelastic loss in a lithium niobate SAW device.

Index Terms—Electrothermoelastic coupling, multi-physics finite-element (M-FE) analysis, piezoelectric materials, thermoelastic effect.

I. INTRODUCTION

SURFACE ACOUSTIC WAVE (SAW) devices are widely used due to the small size, high reliability, and signal processing capability. For instance, SAWs are employed for microparticle separation [1] in flow-based analysis. The SAW-based sensors in biomedical [2] and space research [3] are also broadly used.

A SAW device usually consists of a piezoelectric substrate and deposited interdigital transducers (IDTs). The IDTs can be divided into transmitting and receiving pairs. The SAW can be stimulated when electric signals are applied to the transmitting IDTs. They can then be measured when reaching the receiving IDTs. The part between both pairs is the delay-line area, where sensitive films or fluidic parts can be integrated. Since most of the energy is concentrated near the surface, even very tiny variation in the delay-line area can be detected, which makes the SAW device ideal for sensing and micromanipulation. The operating frequencies are normally located in megahertz range and the thermoelastic attenuation becomes significant [4]. This loss is, in fact, due to cyclic heat flow from the region of compressive stress to the region of tensile stress. Elastic energy is thus partly converted into heat and dissipated.

The mechanism of thermoelastic attenuation of SAW were described in isotropic media [5] and layered structures [6]. Analytical models for quantitative calculation were developed in [7], on the basis of perturbation theory. Even though analytically calculated thermoelastic loss coincided well with the experimental results in simple cases, the developments and assumptions were somehow cumbersome and can be invalid in other cases. For example, microcavities in the substrate are frequently shown in flow-based analysis [1], which makes the homogeneous half space assumption of the substrate no longer hold. The finite-element method, on the other hand, is versatile due to its flexibility in modeling complicated geometry and its capability in obtaining fully coupled multi-physics field solutions. Coupled electrothermoelastic finite-element models have

been built in preceding works [8], [9]. However, these models were mostly for thermal shock problems, thermoelastic damping problems remain to be investigated. Here, we developed a new multi-physics finite-element (M-FE) model dedicating for thermoelastic attenuation in SAW devices. This paper is organized as follows. Governing equations of thermoelastic attenuation in piezoelectric materials and their finite-element formulations are presented in Section II. It is followed by a numerical example of the developed M-FE model applied to the investigation of thermoelastic attenuation in a lithium niobate substrate in both coated and uncoated cases. Finally, the conclusions are drawn in Section IV.

II. MULTI-PHYSICS EQUATIONS AND FINITE-ELEMENT FORMULATIONS

A. Multi-Physics Equations

In what follows, we use the Einstein summation convention to describe different physic equations. Linear theory of thermopiezoelectricity can be found in [9] among others. Primary procedures are adapted and resumed in this section. In the absence of body force, free charge and internal heat generation, the equilibrium relations of the coupled fields can be expressed in (1), where σ_{ij} is the vector of stress tensor, u_i vector of elastic displacement in the i th direction, ρ mass density, q_i vector of heat flux, T_0 initial equilibrium temperature, η entropy density, and D_i vector of electric displacement. A comma subscript followed by an index number i indicates a derivation with respect to the corresponding coordinate direction i

$$\sigma_{ij,j} = \rho \ddot{u}_i \quad (1a)$$

$$q_{i,i} = -T_0 \rho \dot{\eta} \quad (1b)$$

$$D_{i,i} = 0. \quad (1c)$$

By noting with ε_{ij} indicating the vector of strain tensor, E_i vector of electric intensity, ϕ electric potential, k_{ij} tensor

of heat conduction coefficients, and $\theta = T - T_0$ difference between actual and initial temperatures, linear components of elastic, electric, and thermal fields read as follows:

$$\varepsilon_{ij} = (u_{i,j} + u_{j,i})/2 \quad (2a)$$

$$E_i = -\phi_{,i} \quad (2b)$$

$$q_i = -k_{ij}\theta_{,j}. \quad (2c)$$

The constitutive equations can then be expressed by

$$\sigma_{ij} = c_{ijkl}\varepsilon_{kl} + e_{kij}\phi_{,k} - \alpha_{ij}\theta \quad (3a)$$

$$D_i = e_{ikl}\varepsilon_{kl} - p_{ik}\phi_{,k} + d_i\theta \quad (3b)$$

$$\rho\eta = \alpha_{kl}\varepsilon_{kl} - d_k\phi_{,k} + c_E\theta \quad (3c)$$

where c_{ijkl} is the stiffness tensor, e_{ikl} piezoelectric tensor, α_{ij} tensor of thermal stress coefficients, p_{ik} permittivity tensor, d_i vector of pyroelectric coefficients, and c_E the specific heat per unit volume at constant deformation (more detailed definitions of the quantities can be found in [10]). Substitution of (2) and (3) in (1) yields the governing equations, which take the form

$$\rho\ddot{u}_i = c_{ijkl}u_{k,lj} + e_{kij}\phi_{,kj} - \alpha_{ij}\theta_{,j} \quad (4a)$$

$$0 = e_{ikl}u_{k,li} - p_{ik}\phi_{,ki} + d_i\theta_{,i} \quad (4b)$$

$$k_{ij}\theta_{,ij} = T_0(\alpha_{ij}\dot{u}_{i,j} - T_0d_i\dot{\phi}_{,i} + c_E\dot{\theta}). \quad (4c)$$

For multi-physics investigations with (4) in a domain Ω , the boundary conditions along its boundary $\partial\Omega$ should be satisfied. The continuity of u_i , ϕ , and the normal component of D_i , σ_{ijn_j} , and $k_{ij}T_{,jn_j}$ (n_j is the normal unit vector) at an interface have to be fulfilled.

B. Finite-Element Formulations

The variational principle is applied to obtain weak forms. More specifically, equations in (4) are multiplied with the test functions u'_i , ϕ' , and θ' , and integrated by part, respectively. The following equations, in considering corresponding boundary conditions represent the variational form:

$$\int_{\Omega} u'_{i,j} (c_{ijkl}u_{k,l} + e_{kij}\phi_{,k} - \alpha_{ij}\theta) dV + \int_{\Omega} u'_i \rho \ddot{u}_i dV = 0 \quad (5a)$$

$$\int_{\Omega} \phi'_{,i} (e_{ikl}u_{k,li} - p_{ik}\phi_{,k} + d_i\theta) dV = 0 \quad (5b)$$

$$\int_{\Omega} \theta' (T_0\alpha_{ij}\dot{u}_{i,j} - T_0d_i\dot{\phi}_{,i} + c_E\rho\dot{\theta}) dV + \int_{\Omega} \theta'_{,i} k_{ij}\theta_{,j} dV = 0. \quad (5c)$$

They are spatially discretized by interpolating the field unknowns in an element u_e , ϕ_e , and θ_e in terms of nodal degrees of freedom (DoFs) u_k , ϕ_k , and θ_k using appropriate nodal shape functions N_u , N_ϕ , and N_θ , as shown in

$$u_e = N_u u_k \quad \phi_e = N_\phi \phi_k \quad \theta_e = N_\theta \theta_k. \quad (6)$$

For brevity, the following differential matrices are defined:

$$D_u = \begin{bmatrix} \partial/\partial x_1 & 0 & 0 \\ 0 & \partial/\partial x_2 & 0 \\ 0 & 0 & \partial/\partial x_3 \\ \partial/\partial x_1 & \partial/\partial x_2 & 0 \\ 0 & \partial/\partial x_2 & \partial/\partial x_3 \\ \partial/\partial x_1 & 0 & \partial/\partial x_3 \end{bmatrix} \quad (7)$$

$$D_\phi = D_\theta = \begin{bmatrix} \partial/\partial x_1 \\ \partial/\partial x_2 \\ \partial/\partial x_3 \end{bmatrix}.$$

Then, differentials of shape functions can be denoted as

$$\mathbf{B}_u = D_u \mathbf{N}_u \quad \mathbf{B}_\phi = D_\phi \mathbf{N}_\phi \quad \mathbf{B}_\theta = D_\theta \mathbf{N}_\theta. \quad (8)$$

Substituting (6) and (8) into (5) leads to element level equations

$$\mathbf{M}_{uu}^e \ddot{\mathbf{u}}_k + \mathbf{K}_{uu}^e \mathbf{u}_k + \mathbf{K}_{u\phi}^e \phi_k - \mathbf{K}_{u\theta}^e \theta_k = \mathbf{f}_u^e \quad (9a)$$

$$\mathbf{K}_{\phi u}^e \mathbf{u}_k - \mathbf{K}_{\phi\phi}^e \phi_k + \mathbf{K}_{\phi\theta}^e \theta_k = \mathbf{f}_\phi^e \quad (9b)$$

$$\mathbf{K}_{\theta u}^e \dot{\mathbf{u}}_k - \mathbf{K}_{\theta\phi}^e \dot{\phi}_k + \mathbf{H}_{\theta\theta}^e \dot{\theta}_k + \mathbf{K}_{\theta\theta}^e \theta_k = \mathbf{f}_\theta^e \quad (9c)$$

where

$$\mathbf{M}_{uu}^e = \int_{\Omega} \mathbf{N}_u^T \rho \mathbf{N}_u d\Omega \quad \mathbf{K}_{uu}^e = \int_{\Omega} \mathbf{B}_u^T \mathbf{C} \mathbf{B}_u d\Omega$$

$$\mathbf{K}_{u\phi}^e = \int_{\Omega} \mathbf{B}_u^T \mathbf{e}^T \mathbf{B}_\phi d\Omega \quad \mathbf{K}_{u\theta}^e = \int_{\Omega} \mathbf{B}_u^T \boldsymbol{\alpha} \mathbf{N}_\theta d\Omega$$

$$\mathbf{K}_{\phi u}^e = \int_{\Omega} \mathbf{B}_\phi^T \mathbf{e} \mathbf{B}_u d\Omega \quad \mathbf{K}_{\phi\phi}^e = \int_{\Omega} \mathbf{B}_\phi^T \mathbf{p} \mathbf{B}_\phi d\Omega$$

$$\mathbf{K}_{\phi\theta}^e = \int_{\Omega} \mathbf{B}_\phi^T d \mathbf{B}_\theta d\Omega \quad \mathbf{K}_{\theta u}^e = \int_{\Omega} T_0 \mathbf{N}_u^T \boldsymbol{\alpha}^T \mathbf{B}_u d\Omega$$

$$\mathbf{K}_{\theta\phi}^e = \int_{\Omega} T_0 \mathbf{N}_u^T d^T \mathbf{B}_\theta d\Omega \quad \mathbf{K}_{\theta\theta}^e = \int_{\Omega} \mathbf{B}_\theta^T \mathbf{k} \mathbf{B}_\theta d\Omega$$

$$\mathbf{H}_{\theta\theta}^e = \int_{\Omega} \mathbf{N}_\theta^T \rho c_E \mathbf{N}_\theta d\Omega. \quad (10)$$

Element-level matrices are then assembled to form the global equations, as presented in

$$\begin{bmatrix} \mathbf{M}_{uu} & \mathbf{0} & \mathbf{0} \\ \mathbf{0} & \mathbf{0} & \mathbf{0} \\ \mathbf{0} & \mathbf{0} & \mathbf{0} \end{bmatrix} \begin{bmatrix} \ddot{\mathbf{u}} \\ \ddot{\phi} \\ \ddot{\theta} \end{bmatrix} + \begin{bmatrix} \mathbf{0} & \mathbf{0} & \mathbf{0} \\ \mathbf{0} & \mathbf{0} & \mathbf{0} \\ \mathbf{K}_{\theta u} & -\mathbf{K}_{\theta\phi} & \mathbf{H}_{\theta\theta} \end{bmatrix} \begin{bmatrix} \dot{\mathbf{u}} \\ \dot{\phi} \\ \dot{\theta} \end{bmatrix} + \begin{bmatrix} \mathbf{K}_{uu} & \mathbf{K}_{u\phi} & -\mathbf{K}_{u\theta} \\ \mathbf{K}_{\phi u} & -\mathbf{K}_{\phi\phi} & \mathbf{K}_{\phi\theta} \\ \mathbf{0} & \mathbf{0} & \mathbf{K}_{\theta\theta} \end{bmatrix} \begin{bmatrix} \mathbf{u} \\ \phi \\ \theta \end{bmatrix} = \begin{bmatrix} \mathbf{f}_u \\ \mathbf{f}_\phi \\ \mathbf{f}_\theta \end{bmatrix}. \quad (11)$$

Since the unknown DoFs are of different orders of magnitude, it is numerically convenient to treat them as non-dimensional quantities (the asterisk symbol marked as follows) by introducing the following relations [8]:

$$x_i^* = c_0 \zeta_0 x_i, \quad u_i^* = c_0 \zeta_0 u_i, \quad t^* = c_0^2 \zeta_0 t$$

$$\phi^* = c_0^2 \zeta_0 \delta_0 \phi, \quad \theta^* = \theta / T_0, \quad c_0 = \sqrt{c_{33}/\rho}$$

$$\zeta_0 = \rho c_E / k, \quad \delta_0 = e_{33}/c_{33} \quad (12)$$

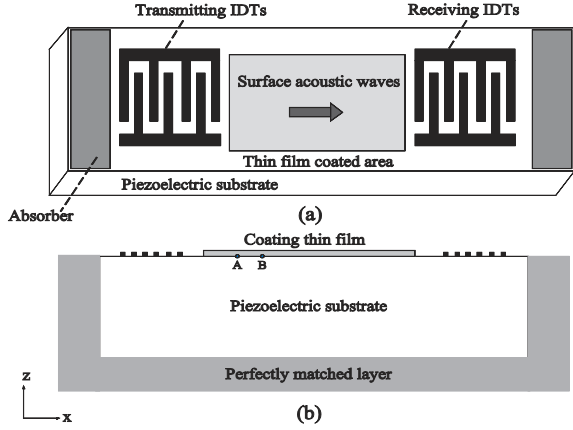


Fig. 1. (a) Typical SAW device schema [14]. (b) 2-D model configuration.

where c_{33} and e_{33} are corresponding components in the stiffness and piezoelectric tensor, respectively, k the heat conduction coefficients, and c_0 the propagating velocity of elastic wave in the solid. Calculated results are converted back to the original quantities for their visibility of physics sense. Equation (11) is integrated in time domain using the Newmark method, being unconditionally stable and of second-order accuracy.

C. Absorbing Boundary Conditions

An important issue worthy noting here is the absorbing boundary condition, i.e., the perfectly matched layer (PML), with which one can avoid wave reflections. Otherwise, larger dimensions need to be constructed wasting too much computing resource. Demonstration of PML in modeling SAW devices in frequency and time domain can be found in [11] and [12], respectively. Time domain implementation is rather complicated due to the frequency dependent nature of some parameters in PML setting. The memory variables [13] are used in the work to avoid convolution terms resulted from the inverse Fourier transform of frequency domain formulations. A three wavelength wide PML boundary is set to sides of the computing domain except for the free surface (as presented in Section III). Reflections are thus successfully avoided; the demand for computing resources is also significantly reduced.

III. NUMERICAL EXAMPLES

A. Modeling of SAWs in Piezoelectric Substrate

The M-FE model is evaluated through modeling of the Rayleigh SAWs propagating in the x -direction and z -direction in a Y -cut LiNbO_3 substrate. A similar configuration [Fig. 1(a)] has been adapted from [14].

Five volts peak-to-peak sinusoidal electric signals of central frequency $f_0 = 300$ MHz are applied to the transmitting IDTs. Corresponding analytical solutions of displacements and potential take the form of (13), in which $\alpha = 1, 2, 3$; b_n indicates the decaying coefficient along z -direction when no other attenuations are accounted for, U_i^n and Φ_i^n are initial values, k the wave number, and v the wave velocity [15]. As (13) indicates, components in y -direction are decoupled. This enables a model in 2-D possible. Fig. 1(b) shows the

TABLE I
MATERIAL CONSTANTS OF THE Y -CUT LITHIUM NIOBATE

Elastic moduli (GPa)	$c_{11} = 203$	$c_{33} = 245$	$c_{12} = 53$
	$c_{44} = 60$	$c_{13} = 75$	$c_{14} = 9$
Piezoelectric const. ($\text{C} \cdot \text{m}^{-2}$)	$e_{15} = 3.7$	$e_{31} = 0.2$	
	$e_{22} = 2.5$	$e_{33} = 1.3$	
Dielectric const. ($10^{-12} \text{F} \cdot \text{m}^{-1}$)	$\epsilon_{11} = 389$	$\epsilon_{33} = 257$	
Thermal expansion coeff. (10^{-5}K^{-1})	$\alpha_{11} = 1.5$	$\alpha_{33} = 0.5$	
Pyroelectric coeff. ($10^{-5} \text{C} \text{K}^{-1} \text{m}^{-2}$)	$P'_z = -4$		
Thermal conductivities ($\text{Jm}^{-1} \text{s}^{-1} \text{K}^{-1}$)	$k_1 = 18.5$	$k_3 = 18.5$	
Specific heat ($10^6 \text{Jm}^{-3} \text{K}^{-1}$)	$c_E = 4.18$		
Mass density ($\text{kg} \cdot \text{m}^{-3}$)	$\rho = 4700$		
Rayleigh wave velocity ($\text{m} \cdot \text{s}^{-1}$)	$v_0 = 3488$		

2-D model in which PML is applied

$$u_\alpha = \sum_{n=1}^2 U_i^n \exp(kb_j z) \exp(ik(x - vt))$$

$$\phi_\alpha = \sum_{n=1}^2 \Phi_i^n \exp(kb_j z) \exp(ik(x - vt)). \quad (13)$$

A program was developed in MATLAB in which a substrate of 30λ wide and 10λ high (λ is the wavelength) was built. 24 electrodes were modeled in transmitting and receiving IDTs, which were separated by 20λ and of period of λ . In the coated situation, the thin film was set to be $1/100\lambda$ and assumed to be isotropic and electrically non-conductive. Delaunay triangular elements were employed with maximal element length set to be $1/32\lambda$, and the time step set to $1/40 T^0$ with $T^0 = 1/f_0$ being the signal period. Electrically grounded and mechanically fixed conditions have been set to the bottom to reduce the second-order effects of the piezoelectric effect [14]. For nodes on the upper surface on which electrodes are supposed to be located, electric potentials are explicitly defined as boundary conditions. In the coated case, continuity of displacement and temperature fields is demanded at the interface. Besides, the surface of the coating material can be regarded as isothermal [4] and electrically non-conductive. Hence, the corresponding thermal and electric DoFs need to be set as identical and ignored, respectively.

Material constants of the substrate are referred to [1] and summarized in Table I. Elastic and thermoelastic constants are set to be identical to, while the specific heat and thermal conductivity of the film to be half of the corresponding values of the substrate.

B. Results and Discussion

A contour plot of displacements in the normal direction is shown in Fig. 2. As can be seen, the wave intensity dies down in the normal direction till null at about three wavelengths away from the surface. In Fig. 3, displacements in the normal direction of points A and B [Fig. 1(b)] are shown. Point A is closer to the stimulating source and locates four wavelengths away from point B. Displacements at both points oscillate at constant amplitudes after sometime. Due to the presence of thermoelastic damping, slight descending in the amplitude in B can be observed. Figs. 2 and 3 qualitatively verified the propagating characteristics of SAW as described by (13).

A quantitatively validation can be found in Fig. 4 in which comparisons between the results of numerical and analytical

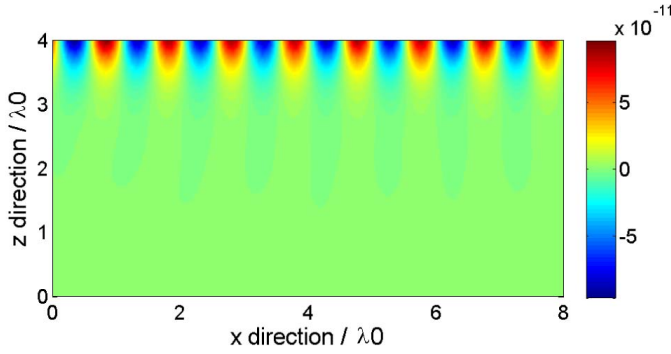


Fig. 2. Contour plot of displacements in z -direction at $15 T_0$.

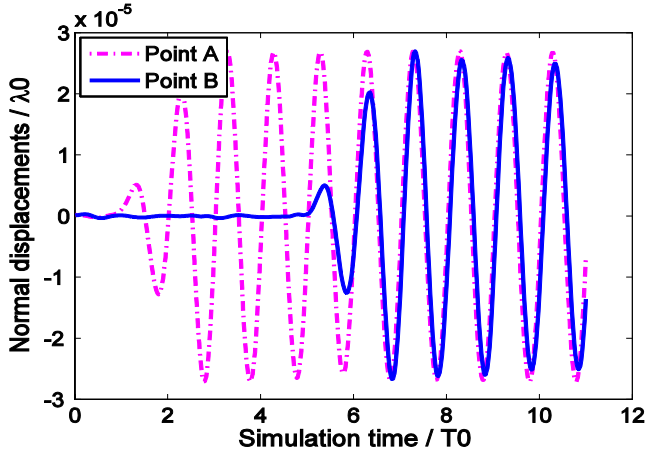


Fig. 3. Displacements in z -direction of points A and B.

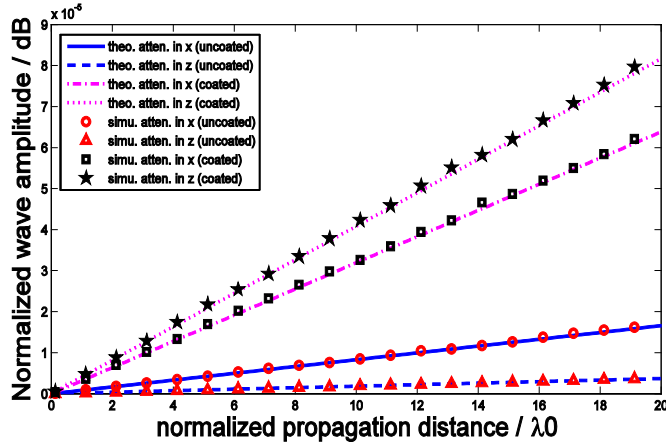


Fig. 4. Wave amplitude versus normalized propagation distance (acoustic attenuation coefficients are proportional to slopes of the lines).

models are demonstrated. In the figure, $-\log(u_\alpha^i/u_\alpha^0)$ versus relative displacements is plotted. u_α^0 indicates displacement in α direction of a reference point. According to the analytical method, the thermoelastic attenuation coefficients in coated condition (upper part) were found to be 13 and 13.3 dB/m for x -direction and z -direction propagation, respectively, whereas those in the uncoated condition (lower part) were 2.7 and 0.6 dB/m, as represented by the lines. Close values were obtained through the M-FE model, as shown by the scattering symbols.

The proposed M-FE model is straightforward and easy to implement. Through general coupled thermopiezoelectric finite-element approach instead of cumbersome development

and excessive simplification in the analytical method, characteristics of the thermoelastic attenuation of the SAW device can be accurately captured. In addition, in modern applications, more complicated geometries are involved in SAW devices, the analytical method becomes no longer applicable. However, though not presented here due to the short of comparable counterparts from the literature (neither analytical nor experimental available to the best of authors knowledge), the proposed method remains an effective approach for simulation.

IV. CONCLUSION

This paper presents a multi-physics finite-element model dedicating for the thermoelastic damping in SAW devices. The model is validated through comparison with an analytical model in which SAWs of 300 MHz propagate in a lithium niobate substrate under both uncoated and thin-film coated conditions. Numerical values accurately predicted the characteristics of thermoelastically attenuated SAWs. We may conclude that the M-FE method can be employed for thermoelastic attenuation investigation in SAW devices. Compared with other simplified methods, benefits can be drawn because of the simplicity and capacity for handling complicated geometries of the proposed methodology.

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